Quad Analog Switch/ Multiplexer/Demultiplexer

High-Performance Silicon-Gate CMOS

The MC74HC4066A utilizes silicon-gate CMOS technology to achieve fast propagation delays, low ON resistances, and low OFF-channel leakage current. This bilateral switch/ multiplexer/demultiplexer controls analog and digital voltages that may vary across the full power-supply range (from V_{CC} to GND).

The HC4066A is identical in pinout to the metal-gate CMOS MC14016 and MC14066. Each device has four independent switches. The device has been designed so the ON resistances (R_{ON}) are more linear over input voltage than R_{ON} of metal-gate CMOS analog switches.

The ON/OFF control inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs. For analog switches with voltage–level translators, see the HC4316A.

Features

- Fast Switching and Propagation Speeds
- High ON/OFF Output Voltage Ratio
- Low Crosstalk Between Switches
- Diode Protection on All Inputs/Outputs
- Wide Power–Supply Voltage Range (V_{CC} GND) = 2.0 to 12.0 V
- Analog Input Voltage Range (V_{CC} GND) = 2.0 to 12.0 V
- Improved Linearity and Lower ON Resistance over Input Voltage than the MC14016 or MC14066
- Low Noise
- Chip Complexity: 44 FETs or 11 Equivalent Gates
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable



ON Semiconductor®

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		MARKING DIAGRAMS
14 1	SOIC-14 D SUFFIX CASE 751A	14 A A A A A A A A A A A A A A A A A A A
14 (1	TSSOP-14 DT SUFFIX CASE 948G	14 HAAAAAA HC 4066A ALYW - 0 - 1 HHHHHH
A WL, Y WW G o	L = Wafer L = Year , W = Work W	

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

PIN ASSIGNMENT

Х _А [1•	14] V _{CC}
Y _A [2	13	A ON/OFF CONTROL
Y _B [3	12	D ON/OFF CONTROL
Х _В [4	11	ן x _D
B ON/OFF CONTROL	5	10	ן א ^D
C ON/OFF CONTROL	6	9] Y _C
GND [7	8	⊐ x _c
·			4

FUNCTION TABLE

On/Off Control Input	State of Analog Switch
L	Off
Н	On



ORDERING INFORMATION

Device	Package	Shipping [†]
MC74HC4066ADG	SOIC-14 (Pb-Free)	55 Units / Rail
MC74HC4066ADR2G	SOIC-14	
NLV74HC4066ADR2G*	(Pb-Free)	2500 / Tape & Reel
MC74HC4066ADTR2G	TSSOP-14	2500 / Tape & Reel
NLVHC4066ADTR2G*	(Pb-Free)	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Positive DC Supply Voltage (Referenced to GND)	– 0.5 to + 14.0	V
V _{IS}	Analog Input Voltage (Referenced to GND)	-0.5 to V_{CC} + 0.5	V
V _{in}	Digital Input Voltage (Referenced to GND)	-0.5 to V_{CC} + 0.5	V
I	DC Current Into or Out of Any Pin	± 25	mA
P _D	Power Dissipation in Still Air, SOIC Package† TSSOP Package†	500 450	mW
T _{stg}	Storage Temperature	– 65 to + 150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP, SOIC or TSSOP Package)	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open. I/O pins must be connected to a properly terminated line or bus.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

†Derating – SOIC Package: – 7 mW/°C from 65° to 125°C

TSSOP Package: - 6.1 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	Positive DC Supply Voltage (Referenced to GND)	2.0	12.0	V
VIS	Analog Input Voltage (Referenced to GND)	GND	V _{CC}	V
V _{in}	Digital Input Voltage (Referenced to GND)	GND	V _{CC}	V
V _{IO} *	Static or Dynamic Voltage Across Switch	-	1.2	V
T _A	Operating Temperature, All Package Types	-55	+ 125	°C
t _r , t _f	Input Rise and Fall Time, ON/OFF Control Inputs (Figure 10) $V_{CC} = 2.0 V$ $V_{CC} = 3.0 V$ $V_{CC} = 4.5 V$ $V_{CC} = 9.0 V$ $V_{CC} = 12.0 V$	0 0 0 0 0	1000 600 500 400 250	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

*For voltage drops across the switch greater than 1.2 V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

DC ELECTRICAL CHARACTERISTIC Digital Section (Voltages Referenced to GND)

				Guaranteed Limit		mit	
Symbol	Parameter	Test Conditions	V _{CC} V	– 55 to 25°C	≤ 85°C	≤ 125°C	Unit
V _{IH}	Minimum High-Level Voltage ON/OFF Control Inputs	R _{on} = Per Spec	2.0 3.0 4.5 9.0 12.0	1.5 2.1 3.15 6.3 8.4	1.5 2.1 3.15 6.3 8.4	1.5 2.1 3.15 6.3 8.4	V
VIL	Maximum Low-Level Voltage ON/OFF Control Inputs	R _{on} = Per Spec	2.0 3.0 4.5 9.0 12.0	0.5 0.9 1.35 2.7 3.6	0.5 0.9 1.35 2.7 3.6	0.5 0.9 1.35 2.7 3.6	V
l _{in}	Maximum Input Leakage Current ON/OFF Control Inputs	V _{in} = V _{CC} or GND	12.0	± 0.1	± 1.0	± 1.0	μΑ
I _{CC}	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC}$ or GND $V_{IO} = 0 V$	6.0 12.0	2 4	20 40	40 160	μΑ

				Guaranteed Limit			
Symbol	Parameter	Test Conditions	V _{CC} V	– 55 to 25°C	≤ 85 °C	≤ 125°C	Unit
R _{on}	Maximum "ON" Resistance	$\label{eq:Vin} \begin{array}{l} V_{in} = V_{IH} \\ V_{IS} = V_{CC} \text{ to GND} \\ I_S \leq 2.0 \text{ mA (Figures 1, 2)} \end{array}$	2.0† 3.0† 4.5 9.0 12.0	- - 120 70 70	- - 160 85 85	- 200 100 100	Ω
		$\label{eq:Vin} \begin{array}{l} V_{in} = V_{IH} \\ V_{IS} = V_{CC} \text{ or GND} \\ (Endpoints) \\ I_S \leq 2.0 \text{ mA (Figures 1, 2)} \end{array}$	2.0 3.0 4.5 9.0 12.0	- - 70 50 50	- - 85 60 60	- - 120 80 80	
ΔR_{on}	Maximum Difference in "ON" Resistance Between Any Two Channels in the Same Package	$\begin{array}{l} V_{in} = V_{IH} \\ V_{IS} = 1/2 \; (V_{CC} - GND) \\ I_{S} \leq 2.0 \; mA \end{array} \label{eq:Vin}$	2.0 4.5 9.0 12.0	- 20 15 15	- 25 20 20	- 30 25 25	Ω
I _{off}	Maximum Off-Channel Leakage Current, Any One Channel	$V_{in} = V_{IL}$ $V_{IO} = V_{CC}$ or GND Switch Off (Figure 3)	12.0	0.1	0.5	1.0	μΑ
I _{on}	Maximum On-Channel Leakage Current, Any One Channel	$V_{in} = V_{IH}$ $V_{IS} = V_{CC}$ or GND (Figure 4)	12.0	0.1	0.5	1.0	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. †At supply voltage (V_{CC}) approaching 3 V the analog switch-on resistance becomes extremely non-linear. Therefore, for low-voltage operation, it is recommended that these devices only be used to control digital signals.

AC ELECTRICAL CHARACTERISTICS (C_L = 50 pF, ON/OFF Control Inputs: t_r = t_f = 6 ns)

			Gu	mit		
Symbol	Parameter	v _{cc} v	– 55 to 25°C	≤ 85 °C	≤ 125°C	Unit
t _{PLH} ,	Maximum Propagation Delay, Analog Input to Analog Output	2.0	40	50	60	ns
t _{PHL}	(Figures 8 and 9)	3.0	30	40	50	
		4.5	10	13	15	
		9.0	10	13	15	
		12.0	10	13	15	
t _{PLZ} ,	Maximum Propagation Delay, ON/OFF Control to Analog Output	2.0	80	90	110	ns
t _{PHZ}	(Figures 10 and 11)	3.0	60	70	80	
		4.5	30	38	45	
		9.0	25	28	30	
		12.0	25	28	30	
t _{PZL} ,	Maximum Propagation Delay, ON/OFF Control to Analog Output	2.0	80	90	100	ns
t _{PZH}	(Figures 10 and 1 1)	3.0	45	50	60	
		4.5	25	32	37	
		9.0	25	32	37	
		12.0	25	32	37	
С	Maximum Capacitance ON/OFF Control Input	-	10	10	10	pF
	Control Input = GND					
	Analog I/O	-	35	35	35	
	Feedthrough	-	1.0	1.0	1.0	
		Typical @ 25°C, V _{CC} = 5.0 V				
C _{PD}	Power Dissipation Capacitance (Per Switch) (Figure 13)*		1	5		pF

* Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

ADDITIONAL APPLICATION CHARACTERISTICS (Voltages Referenced to GND Unless Noted)

Symbol	Parameter	Test Conditions	V _{CC} V	Limit* 25°C 54/74HC	Unit
BW	Maximum On-Channel Bandwidth or Minimum Frequency Response (Figure 5)	$ \begin{array}{l} f_{in} = 1 \mbox{ MHz Sine Wave} \\ \mbox{Adjust } f_{in} \mbox{ Voltage to Obtain 0 dBm at } V_{OS} \\ \mbox{Increase } f_{in} \mbox{ Frequency Until dB Meter Reads} - 3 \mbox{ dB} \\ R_L = 50 \Omega, C_L = 10 \mbox{ pF} \end{array} $	4.5 9.0 12.0	150 160 160	MHz
_	Off-Channel Feedthrough Isolation (Figure 6)	$ \begin{array}{l} f_{in} \equiv \text{Sine Wave} \\ \text{Adjust} \ f_{in} \ \text{Voltage to Obtain 0 dBm at V}_{IS} \\ f_{in} = 10 \ \text{kHz}, \ \text{R}_{L} = 600 \ \Omega, \ \text{C}_{L} = 50 \ \text{pF} \end{array} $	4.5 9.0 12.0	- 50 - 50 - 50	dB
		f_{in} = 1.0 MHz, R_L = 50 Ω , C_L = 10 pF	4.5 9.0 12.0	- 40 - 40 - 40	
-	Feedthrough Noise, Control to Switch (Figure 7)	$ \begin{split} V_{in} &\leq 1 \text{ MHz Square Wave } (t_r = t_f = 6 \text{ ns}) \\ \text{Adjust } R_L \text{ at Setup so that } I_S = 0 \text{ A} \\ R_L = 600 \ \Omega \text{, } C_L = 50 \text{ pF} \end{split} $	4.5 9.0 12.0	60 130 200	mV _{PP}
		R_L = 10 k Ω , C_L = 10 pF	4.5 9.0 12.0	30 65 100	
-	Crosstalk Between Any Two Switches (Figure 12)	$ \begin{array}{l} f_{in} \equiv \text{Sine Wave} \\ \text{Adjust } f_{in} \text{ Voltage to Obtain 0 dBm at V}_{IS} \\ f_{in} = 10 \text{ kHz}, \text{ R}_L = 600 \ \Omega, \text{ C}_L = 50 \text{ pF} \end{array} $	4.5 9.0 12.0	- 70 - 70 - 70	dB
		f_{in} = 1.0 MHz, R_L = 50 Ω , C_L = 10 pF	4.5 9.0 12.0	- 80 - 80 - 80	
THD	Total Harmonic Distortion (Figure 14)	$\label{eq:fin} \begin{array}{l} f_{in} = 1 \text{ kHz}, \text{R}_{L} = 10 \text{k}\Omega, \text{C}_{L} = 50 \text{pF} \\ \text{THD} = \text{THD}_{Measured} - \text{THD}_{Source} \\ \text{V}_{IS} = 4.0 \text{V}_{PP} \text{ sine wave} \\ \text$	4.5 9.0 12.0	0.10 0.06 0.04	%

*Guaranteed limits not tested. Determined by design and verified by qualification.



 $\mathsf{V}_{\mathsf{is}},$ INPUT VOLTAGE (VOLTS), REFERENCED TO GROUND





Figure 1b. Typical On Resistance, V_{CC} = 3.0 V







Figure 1e. Typical On Resistance, V_{CC} = 9.0 V





Figure 2. On Resistance Test Set-Up



Figure 3. Maximum Off Channel Leakage Current, Any One Channel, Test Set–Up



Figure 4. Maximum On Channel Leakage Current, Test Set-Up



*Includes all probe and jig capacitance.





*Includes all probe and jig capacitance.

Figure 6. Off–Channel Feedthrough Isolation, Test Set–Up



*Includes all probe and jig capacitance.





Figure 8. Propagation Delays, Analog In to Analog Out



*Includes all probe and jig capacitance.

Figure 9. Propagation Delay Test Set-Up



*Includes all probe and jig capacitance.

Figure 11. Propagation Delay Test Set-Up



Figure 13. Power Dissipation Capacitance Test Set–Up



Figure 10. Propagation Delay, ON/OFF Control to Analog Out



*Includes all probe and jig capacitance.

Figure 12. Crosstalk Between Any Two Switches, Test Set-Up



*Includes all probe and jig capacitance.

Figure 14. Total Harmonic Distortion, Test Set-Up



Figure 15. Plot, Harmonic Distortion

APPLICATION INFORMATION

The ON/OFF Control pins should be at V_{CC} or GND logic levels, V_{CC} being recognized as logic high and GND being recognized as a logic low. Unused analog inputs/outputs may be left floating (not connected). However, it is advisable to tie unused analog inputs and outputs to V_{CC} or GND through a low value resistor. This minimizes crosstalk and feedthrough noise that may be picked–up by the unused I/O pins.

The maximum analog voltage swings are determined by the supply voltages V_{CC} and GND. The positive peak analog voltage should not exceed V_{CC} . Similarly, the negative peak analog voltage should not go below GND. In the example below, the difference between V_{CC} and GND is twelve volts. Therefore, using the configuration in Figure 16, a maximum analog signal of twelve volts peak-to-peak can be controlled.

When voltage transients above V_{CC} and/or below GND are anticipated on the analog channels, external diodes (Dx) are recommended as shown in Figure 17. These diodes should be small signal, fast turn-on types able to absorb the maximum anticipated current surges during clipping. An alternate method would be to replace the Dx diodes with Mosorbs (MosorbTM is an acronym for high current surge protectors). Mosorbs are fast turn-on devices ideally suited for precise DC protection with no inherent wear out mechanism.



Figure 16. 12 V Application



Figure 17. Transient Suppressor Application



Figure 18. LSTTL/NMOS to HCMOS Interface



Figure 19. TTL/NMOS-to-CMOS Level Converter Analog Signal Peak-to-Peak Greater than 5 V (Also see HC4316A)



Figure 20. 4–Input Multiplexer



Figure 21. Sample/Hold Amplifier





*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DATE 03 FEB 2016

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STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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